



## 5630

### Semi-automatic Wedge-Wedge- Bonder

The semi-automatic Wedge-Wedge Bonder 5630 fills the gap between the manual Wedge-to the automatic-bonder. He is on basis 5600-series fully PC controlled and allows any number of bonds to be programmed.

Pre-programmed adjust points are targeted through the camera's cross hair targeting system and the programmed bonds are executed automatically.

Two operating modes are available: Single bond for repair of various bond samples and making single bonds (manual-automatic) and multi wire for teaching and bonding chips or various bond samples (semi and fully automatic).

The 5630 can also be used as Gold Wire or Alu Heavy Wire as well as pull-/shear tester by simply replacing the bond head and loading the appropriate software.

change over time: approx. 5 minutes.

Ask us for more information !

#### Specifications

##### Mechanics

*X, Y table* Working area 100 x 115 mm  
Resolution 0.25  $\mu\text{m}$ , repeatability < 2  $\mu\text{m}$

*Z-axis* 60 mm

*Speed* up to  $\leq 20$  wires / min.

*Bond head* Wedge-Wedge Thin-Wire (Au/Al)

Axis of rotation  $\pm 360^\circ$

*Ultrasonic system* 60KHz / 100KHz optional 140KHz

*Wire size* 17,5 $\mu\text{m}$  up to 75 $\mu\text{m}$

##### Control

*Heating-controller* Integrated in machine 0 - 250°C

*Computer* Dual Core PC, 1,6 GHz processor,  
4 GB RAM, Ethernet, USB 4x + 4x frontside

*Monitor* TFT flat screen

*Operation system* Windows 7

*Printer* All Windows-compatible printers can be installed  
All bonding parameters can be printed

*Work holder*  $\varnothing$  80mm or 4x4"

*Heated work holder*  $\varnothing$  80mm and optional 4x4"  
(mech. / vacuum)

(Attention: 4x4" up to 200°C; 80 mm up to 250°C)

## Other features

*Programming:* Automatic bonding of hybrids or COB with programmable X/Y table

## Work holders



For components up to 4 x 4"  
Vacuum and mech. clamping

## Heated Substrathalter optional



For components up to 4 x 4"  
Vacuum and mech. clamping  
heated



for components up to  $\varnothing$  80 mm  
Vacuum and mech. clamping  
heated

More Work holders available on request.

**Head Parking System** For storing of temporary not required bondhead or pull- and shear-heads.  
Can be mounted on the left or right side of the machine

## General

*Camera* With cross hair targeting for positioning of bonds

*Microscope* Stereoskop Standard 40x, other Microscopes optional

*Lighting* 20 W halogen spot light, optional LED direct light  
Incident light optional

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<i>Dimensions</i>	Height 70 cm, width 70 cm, depth 65 cm; approx. 70 kg
<i>Supplies</i>	100...240 VAC, single-phase, 50/60 Hz, max. 500 VA
<i>Connections</i>	Air 6 bar, vacuum 0,7 bar $\varnothing$ 6 mm